

#### 100V NPN HIGH VOLTAGE TRANSISTOR IN TO252 (DPAK)

### **Description**

This Bipolar Junction Transistor (BJT) is designed to meet the stringent requirements of Automotive Applications.

#### **Features**

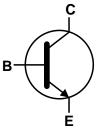
- BV<sub>CEO</sub> > 100V
- I<sub>C</sub> = 3A high Continuous Collector Current
- I<sub>CM</sub> = 5A Peak Pulse Current
- Ideal for Power Switching or Amplification Applications
- Complementary PNP Type: MJD32CUQ
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

### **Mechanical Data**

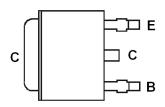
- Case: TO252 (DPAK)
- Case Material: Molded Plastic, "Green" Molding Compound UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202. Method 208 <sup>®</sup>3
- Weight: 0.34 grams (Approximate)







**Device Schematic** 



Pin Out Configuration Top View

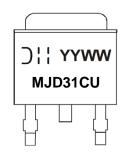
#### Ordering Information (Notes 4 & 5)

Part number	Compliance	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
MJD31CUQ-13	Automotive	MJD31CU	13	16	2,500

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

- See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to http://www.diodes.com/product\_compliance\_definitions.html.
- 5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

## **Marking Information**





# **Absolute Maximum Ratings** (@ $T_A = +25^{\circ}C$ , unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V <sub>CBO</sub>	120	V
Collector-Emitter Voltage	V <sub>CEO</sub>	100	V
Emitter-Base Voltage	V <sub>EBO</sub>	7	V
Continuous Collector Current	Ic	3	A
Peak Pulse Collector Current	I <sub>CM</sub>	5	A
Continuous Base Current	I <sub>B</sub>	1	A
Power Dissipation	P <sub>D</sub>	15	W

# Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
	(Note 6)		3.9		
Power Dissipation	(Note 7)	$P_D$	2.1	W	
	(Note 8)		1.6		
	(Note 6)		32		
Thermal Resistance, Junction to Ambient Air	(Note 7)	$R_{ heta JA}$	59	2000	
	(Note 8)		80	°C/W	
Thermal Resistance, Junction to Leads	(Note 9)	$R_{ heta JL}$	3.6		
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C		

### ESD Ratings (Note 10)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	С

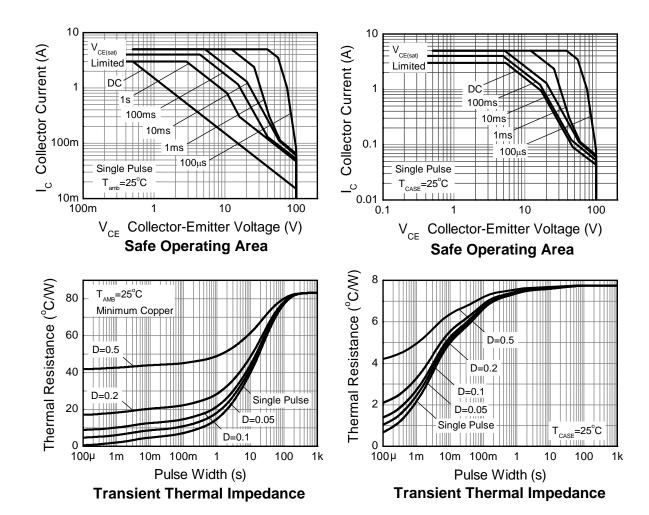
Notes:

- 6. For a device mounted with the exposed collector pad on 50mm x 50mm 2oz copper that is on a single-sided 1.6mm FR-4 PCB; device is measured under still air conditions whilst operating in a steady-state.
- 7. Same as note (6), except mounted on 25mm x 25mm 1oz copper.

  8. Same as note (6), except mounted on minimum recommended pad (MRP) layout.
- Thermal resistance from junction to solder-point (on the exposed collector pad).
   Refer to JEDEC specification JESD22-A114 and JESD22-A115.



### **Thermal Characteristics**





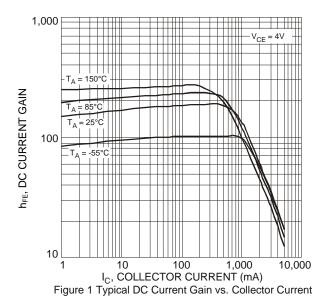
# **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

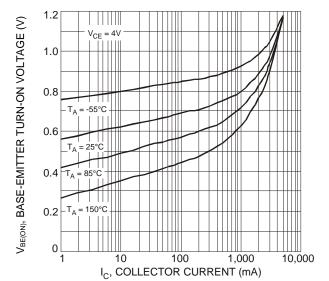
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV <sub>CBO</sub>	120	1	-	V	$I_C = 20\mu A$
Collector-Emitter Breakdown Voltage (Note 11)	$BV_{CEO}$	100	-	-	V	$I_C = 30mA$
Emitter-Base Breakdown Voltage	$BV_{EBO}$	7	ı	-	V	$I_E = 100\mu A$
Collector-Base Cut-off Current	I <sub>CBO</sub>	_	1	1	μΑ	V <sub>CB</sub> = 100V
Collector Cut-off Current	I <sub>CEO</sub>	=	ı	1	μA	V <sub>CE</sub> = 60V
Collector Cut-off Current	I <sub>CES</sub>	-	1	1	μΑ	V <sub>CE</sub> = 100V
Emitter Cut-off Current	I <sub>EBO</sub>	_	1	1	μΑ	$V_{EB} = 5V$
		-	_	300	mV	$I_C = 1A$ , $I_B = 100mA$
Collector-Emitter Saturation Voltage (Note 11)	V <sub>CE(sat)</sub>	_	-	500	mV	$I_C = 2A$ , $I_B = 200mA$
		=	ı	700	mV	$I_C = 3A$ , $I_B = 375mA$
Base-Emitter Saturation Voltage (Note 11)	V <sub>BE(sat)</sub>	-	_	1.2	V	$I_C = 2A$ , $I_B = 200mA$
Base-Emitter Turn-On Voltage (Note 11)	V	=	-	950	mV	$I_C = 1A$ , $V_{CE} = 2V$
base-Emilier Fum-On Vollage (Note 11)	V <sub>BE(on)</sub>	-	_	1.4	V	$I_C = 3A$ , $V_{CE} = 4V$
DC Current Gain (Note 11)	h <sub>FE</sub>	25		-	_	$V_{CE} = 4V, I_C = 1A$
DC Current Gain (Note 11)		10	ĺ	50	_	$V_{CE} = 4V$ , $I_C = 3A$
Current Signal Current Gain	H <sub>fe</sub>	20	ı	-	-	$V_{CE} = 10V$ , $I_{C} = 0.5A$ , $f = 1kHz$
Current Gain-Bandwidth Product	f⊤	3.0	-	_	MHz	$I_C = 0.5A$ , $V_{CE} = 10V$ , $f = 1MHz$

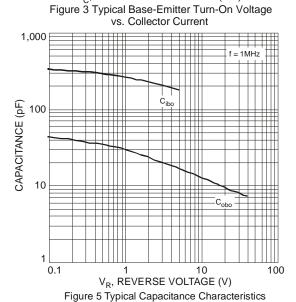
Note: 11. Measured under pulsed conditions. Pulse width  $\leq$  300 $\mu$ s. Duty cycle  $\leq$  2%.



## Typical Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)







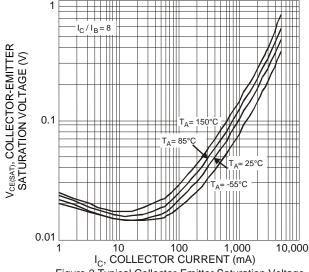


Figure 2 Typical Collector-Emitter Saturation Voltage vs. Collector Current

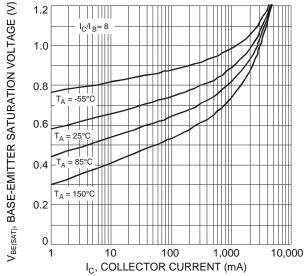


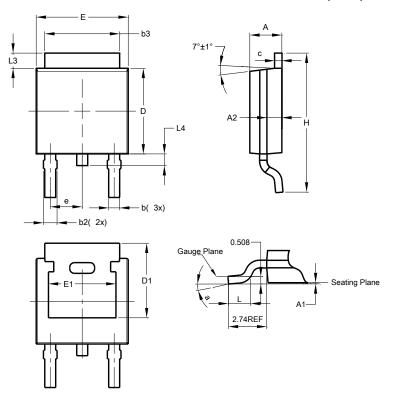
Figure 4 Typical Base-Emitter Saturation Voltage vs. Collector Current



### **Package Outline Dimensions**

 $\label{lem:please} Please see \ http://www.diodes.com/package-outlines.html \ for \ the \ latest \ version.$ 

#### TO252 (DPAK)

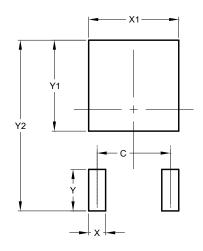


TO252 (DPAK)					
Dim	Min	Max	Тур		
Α	2.19	2.39	2.29		
<b>A</b> 1	0.00	0.13	0.08		
A2	0.97	1.17	1.07		
b	0.64	0.88	0.783		
b2	0.76	1.14	0.95		
b3	5.21	5.46	5.33		
С	0.45	0.58	0.531		
D	6.00	6.20	6.10		
D1	5.21	-	-		
е	-	-	2.286		
Е	6.45	6.70	6.58		
E1	4.32	-	-		
Н	9.40	10.41	9.91		
٦	1.40	1.78	1.59		
L3	0.88	1.27	1.08		
L4	0.64	1.02	0.83		
а	0°	10°	-		
All Dimensions in mm					

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### TO252 (DPAK)



Dimensions	Value (in mm)		
С	4.572		
Х	1.060		
X1	5.632		
Υ	2.600		
Y1	5.700		
Y2	10.700		

Note: For high voltage applications, the appropriate industry sector guidelines should be considered with regards to creepage and clearance distances between device Terminals and PCB tracking.



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